

From Concept to Simulation: SIMTEC, your COMSOL Partner for Game-Changing Innovation

Humusoft COMSOL Conference 2025
May 22th 2025

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Outline

- I. SIMTEC : Who we are
- II. Case study 1: Heat dissipation in a head lamp
- III. Case study 2: Thermal and mechanical multiscale modelling
- IV. Q&A session

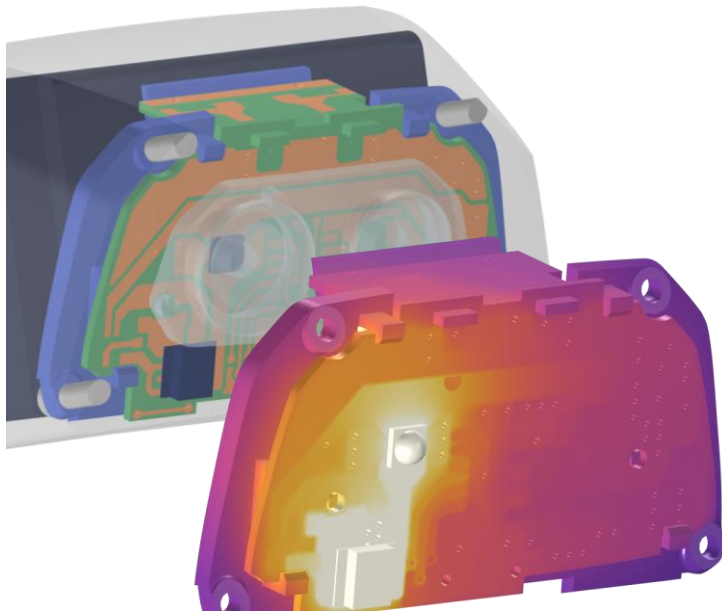
SIMTEC: Who we are... www.simtec solution.fr

SIMTEC : Fundamentals

- French Numerical modelling consultancy
- Leader in France of the COMSOL Certified Consultants, key partner worldwide
- 9 members Eng.D. + Ph.D.
- Main partners:
 - big international companies
 - laboratories
- Involved in the Research projects like EU FP (SHARK, SisAI)/ PhD supervision



Case study 1: Heat dissipation in a head lamp



Modelling the Heat Dissipation of a Head Lamp within COMSOL Multiphysics®

F. Viry¹, P. Namy¹, C. Dupuis²

¹ SIMTEC, Grenoble (France)

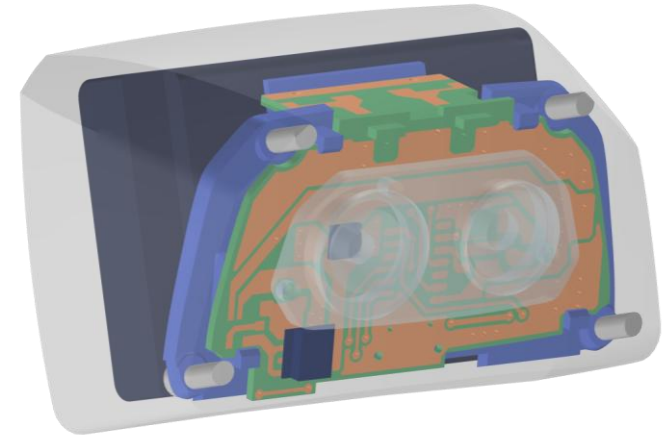
² Decathlon B'twin Village, Lille (France)

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Case study 1: Heat dissipation in a head lamp

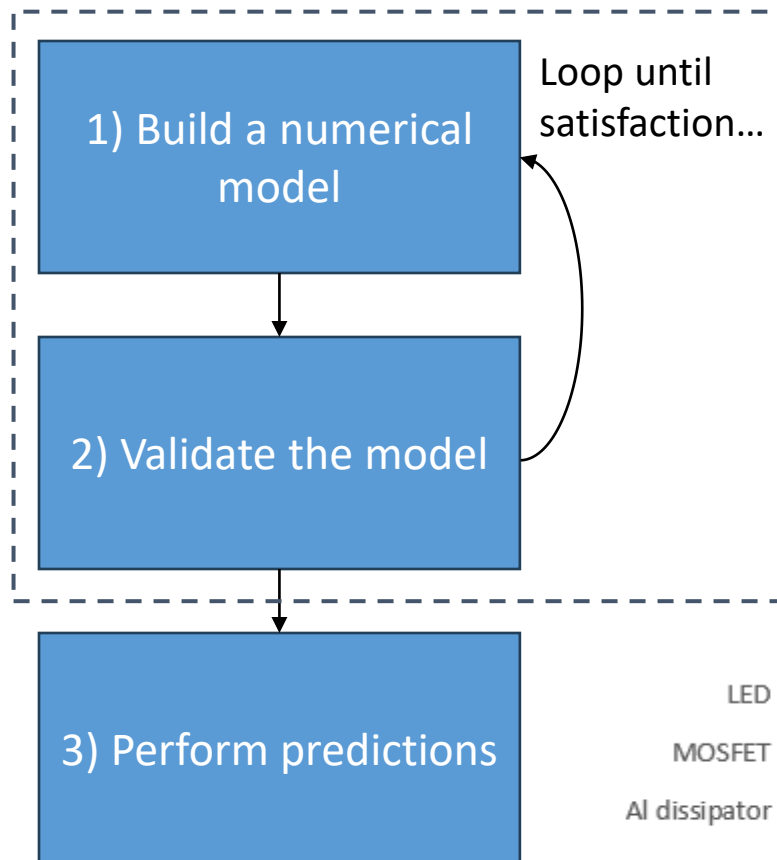
Context and objectives

- Serial production of head lamps
 - **Goal: reducing the environmental footprint**
 - Employing other materials having other properties...
 - ... Requiring to redesign some parts
- Thermal performance of new designs?
- ☐ No overheating of the electronic components
 - ☐ No hot spots neat the user
- **Estimating the heat dissipation performances using a numerical model!**

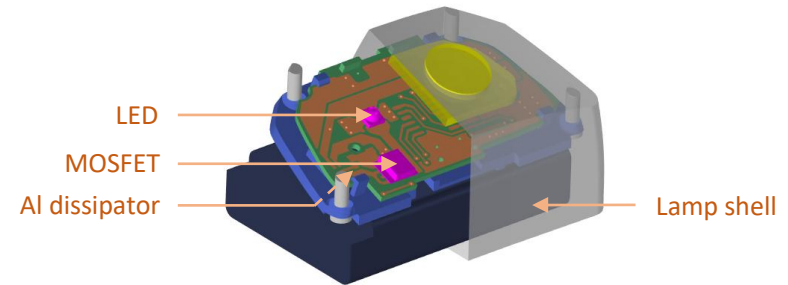


Case study 1: Heat dissipation in a head lamp

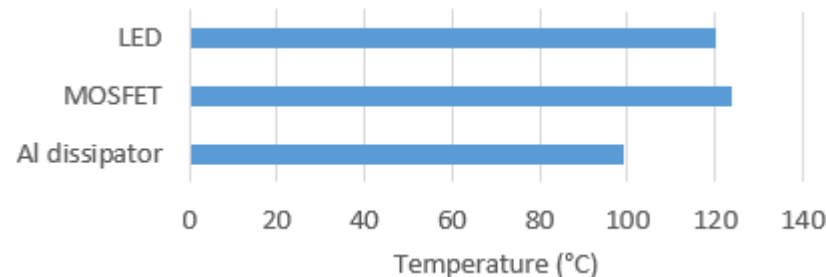
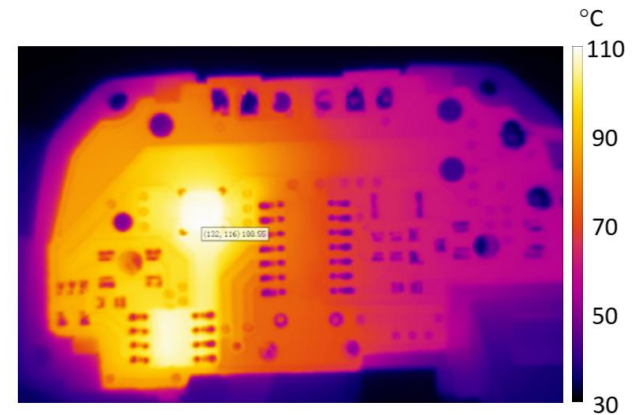
Context and objectives



A few components of the lamp



Experimental temperatures: open lamp (no shell)



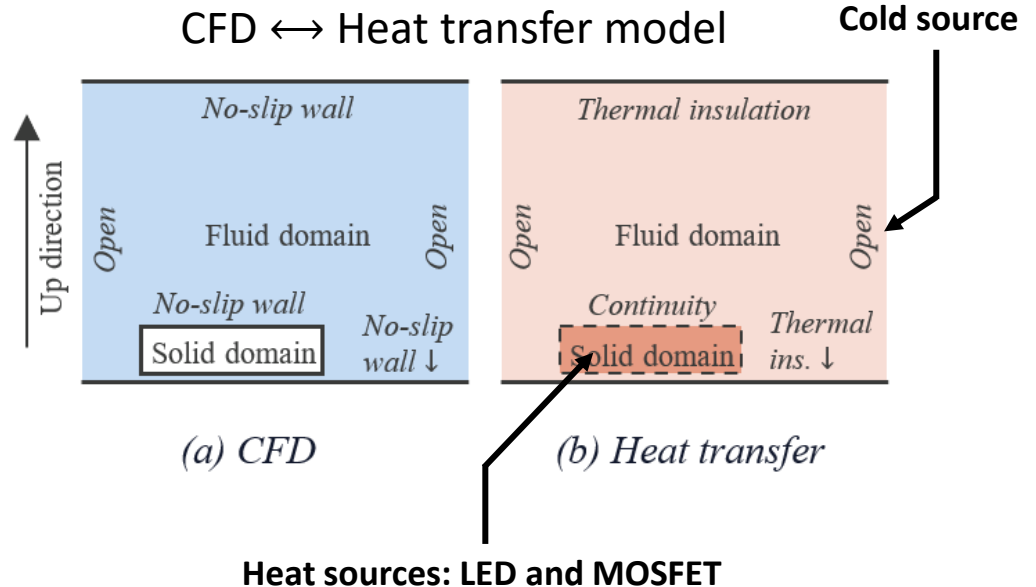
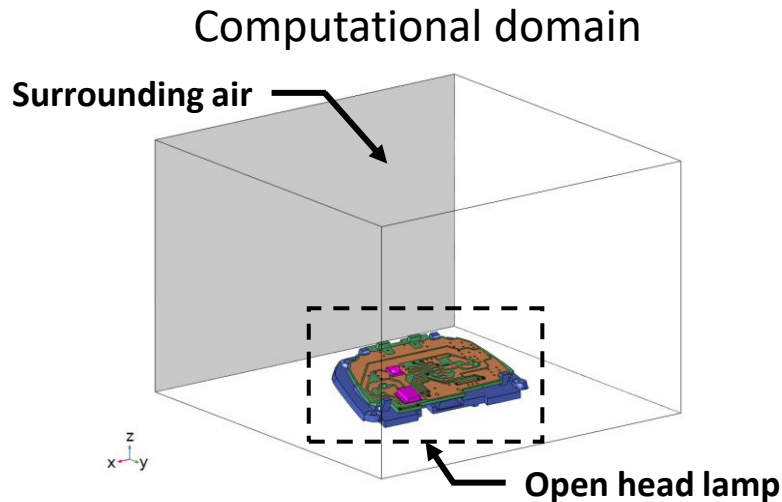
Experimental temperatures: closed lamp

Case study 1: Heat dissipation in a head lamp

Modelling – Open lamp

Hypotheses:

- Main heat dissipation processes: **conduction** and **natural convection** (no radiation)
- **Laminar** natural convection (Grashof number)



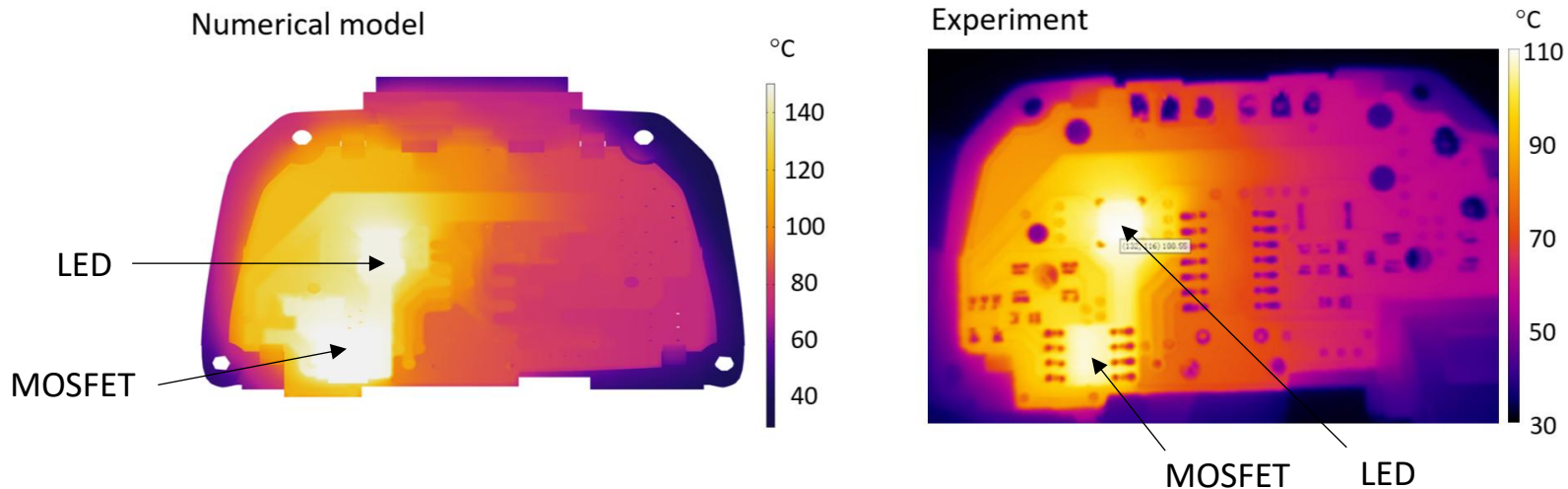
→ Solved at steady-state

→ **Conduction + Natural convection : very natural coupling in COMSOL Multiphysics!**

Case study 1: Heat dissipation in a head lamp

Results – Open lamp

Temperature cartography: numerical model vs. experiment



Qualitative agreement ✓

Quantitatively: numerical temperatures \gg experimental temperatures

→ Very good first step!

→ But a dissipation process seems to be missing: radiative transfers

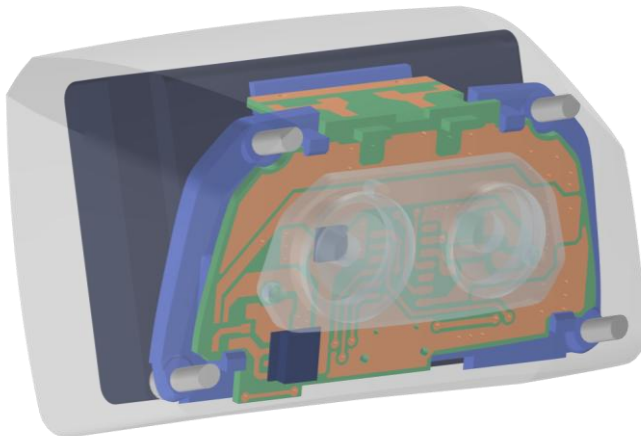
Case study 1: Heat dissipation in a head lamp

Modelling – Closed lamp

Hypotheses:

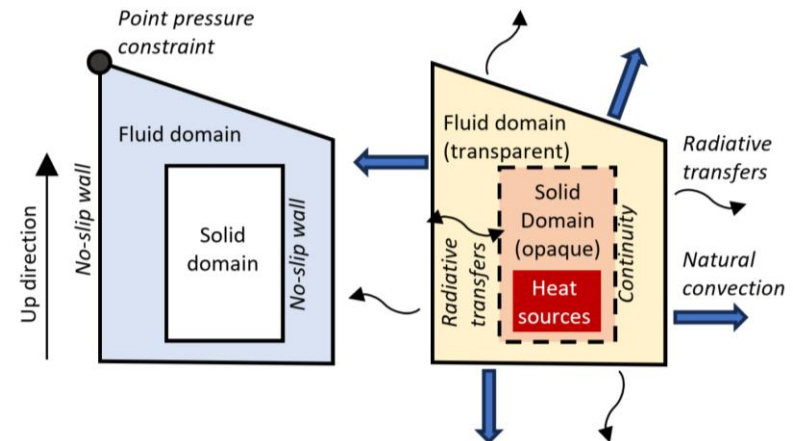
- Main heat dissipation processes: ~~conduction~~ and ~~natural convection~~ (no radiation)
- **Laminar** natural convection (Grashof number)

Computational domain



Surrounding air is not explicitly represented

CFD ↔ Heat transfer model



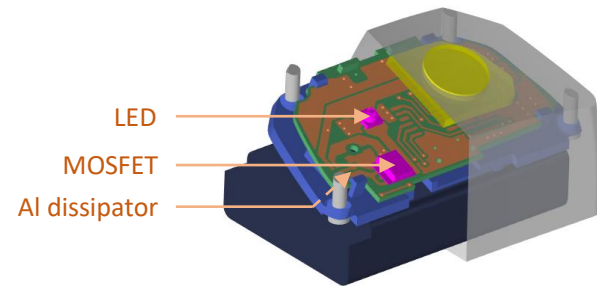
→ Solved at steady-state

→ **Conduction + Natural convection + Surface-to-surface radiation: still a very natural coupling in COMSOL Multiphysics!**

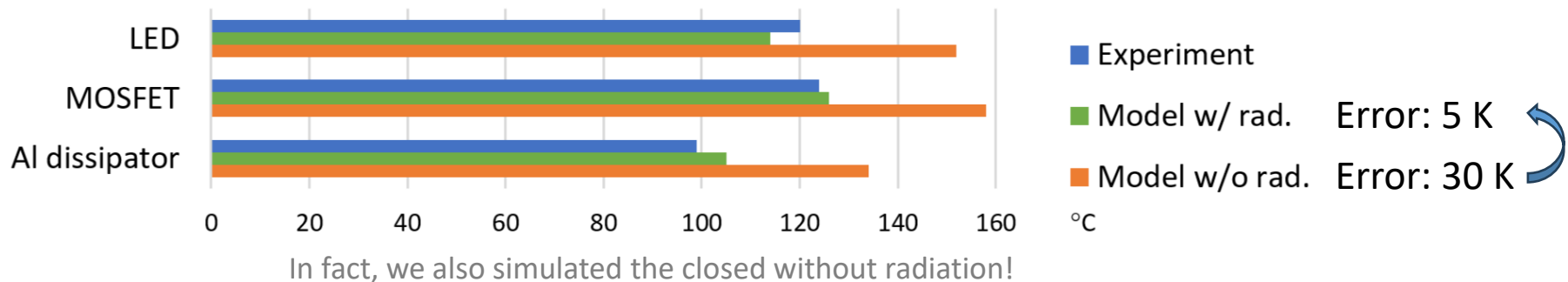
Case study 1: Heat dissipation in a head lamp

Results – Closed lamp

A few components of the lamp



Local temperature measurements: numerical model vs. experiment



→ By taking into account radiation: the model is far more accurate! ✓

→ Validated model: ready to make predictions and answer design issues! ✓

Case study 1: Heat dissipation in a head lamp

Conclusions and Perspectives

→ Modelling is an iterative process:

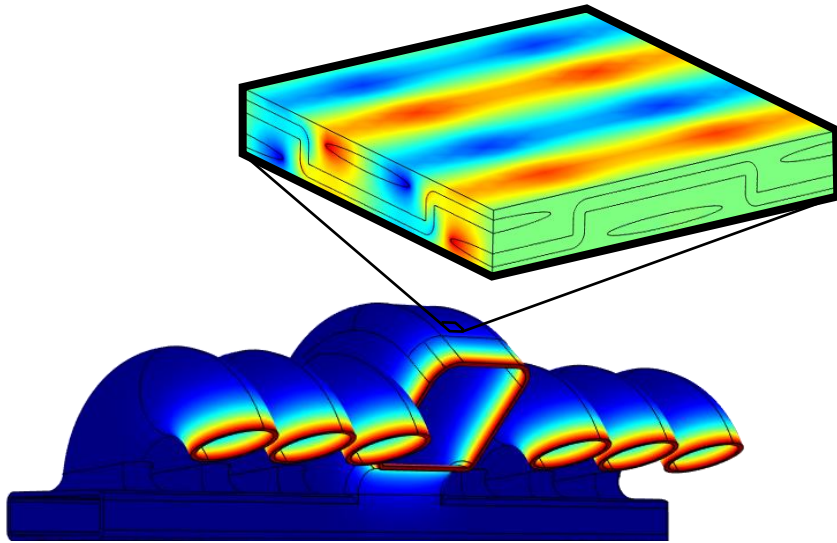
- 1) We make simplifying hypotheses
- 2) We build models upon these
- 3) Whenever it's possible: we compare the model with experiments
- 4) We get back to step 1) until the model is accurate enough

→ COMSOL is a well adapted tool to efficiently address heat transfer issues in complex geometries:

- CAD imports and geometry operations
- Very natural couplings (physics, solvers...)

→ On this specific case study: we developed an accurate head lamp thermal model, making it possible to evaluate heat dissipation performance of new designs

Case study 2: Thermal and mechanical multiscale modelling



Heat Transfers and Solid Mechanics in Microarchitected Materials using Periodic Homogenization

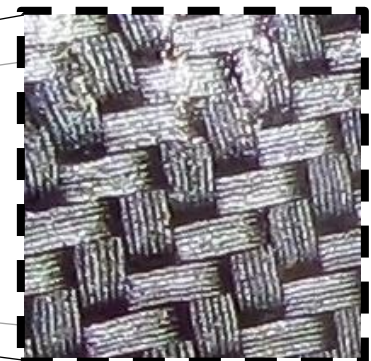
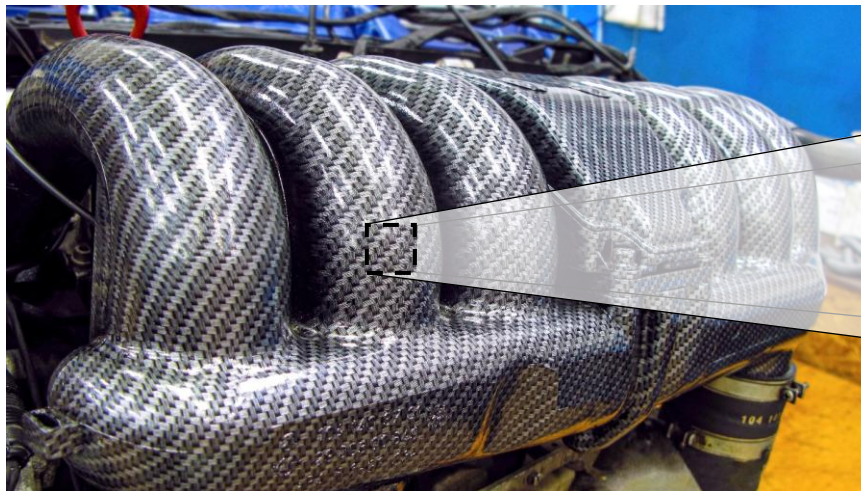
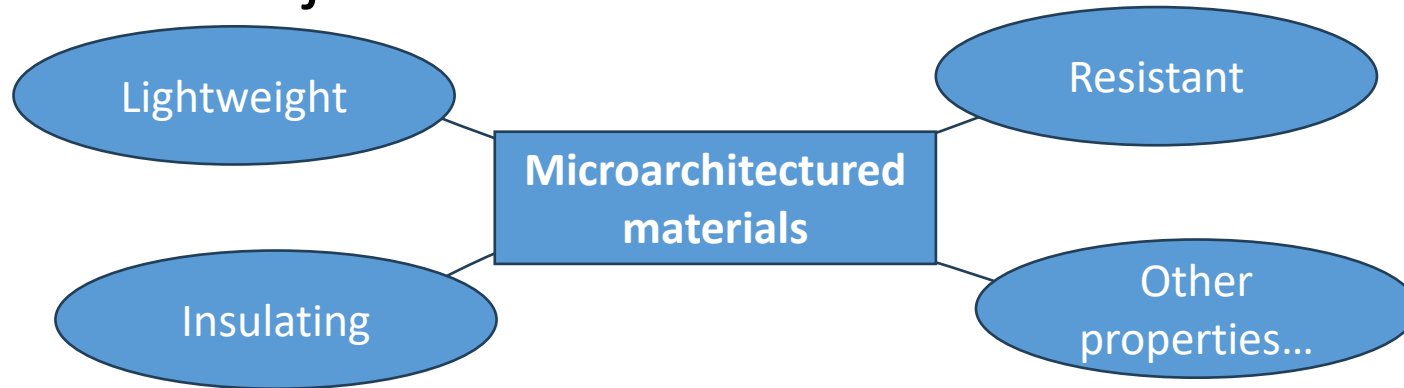
F. Viry¹, J.-D. Wheeler¹, P. Namy¹

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Case study 2: Thermal and mechanical multiscale modelling

Context and objectives



Carbon fiber pattern

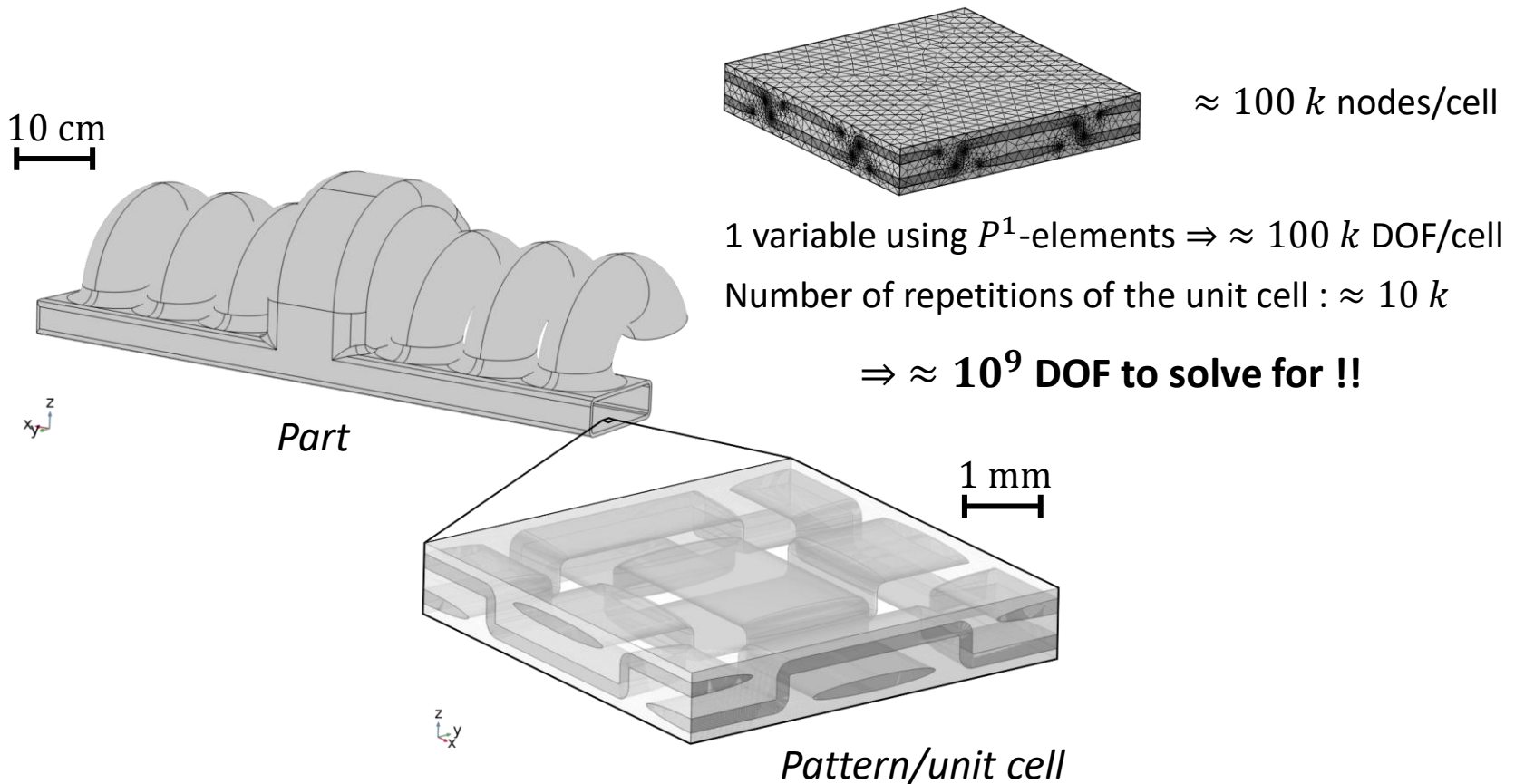
Intake manifold photo from Shutterstock

→ How to design and evaluate the performance of my part using such materials?

Case study 2: Thermal and mechanical multiscale modelling

Context and objectives

What about direct FEA?

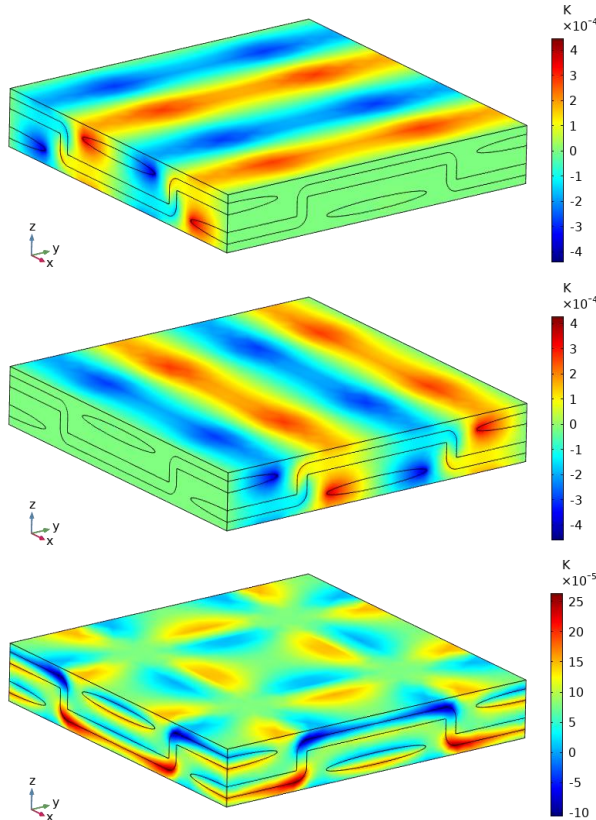


→ We must rely on a more sophisticated approach: *e.g.* periodic homogenization method!

Case study 2: Thermal and mechanical multiscale modelling

Modelling – Principles of periodic homogenization

Step 1: submit the microstructure to unitary solicitations (FEM computations)

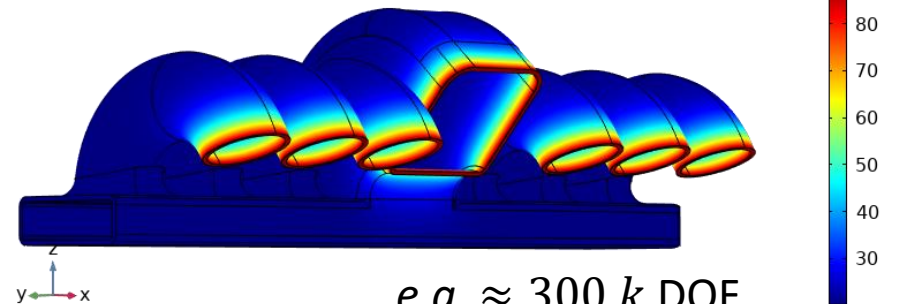


e.g. $\approx 100 \text{ k}$ DOF/computation

Step 2: compute homogenized properties (post-treatments)

- Conductivity matrix
- Elasticity tensor
- ...

Step 3: compute state of the homogenized part (FEM computation)

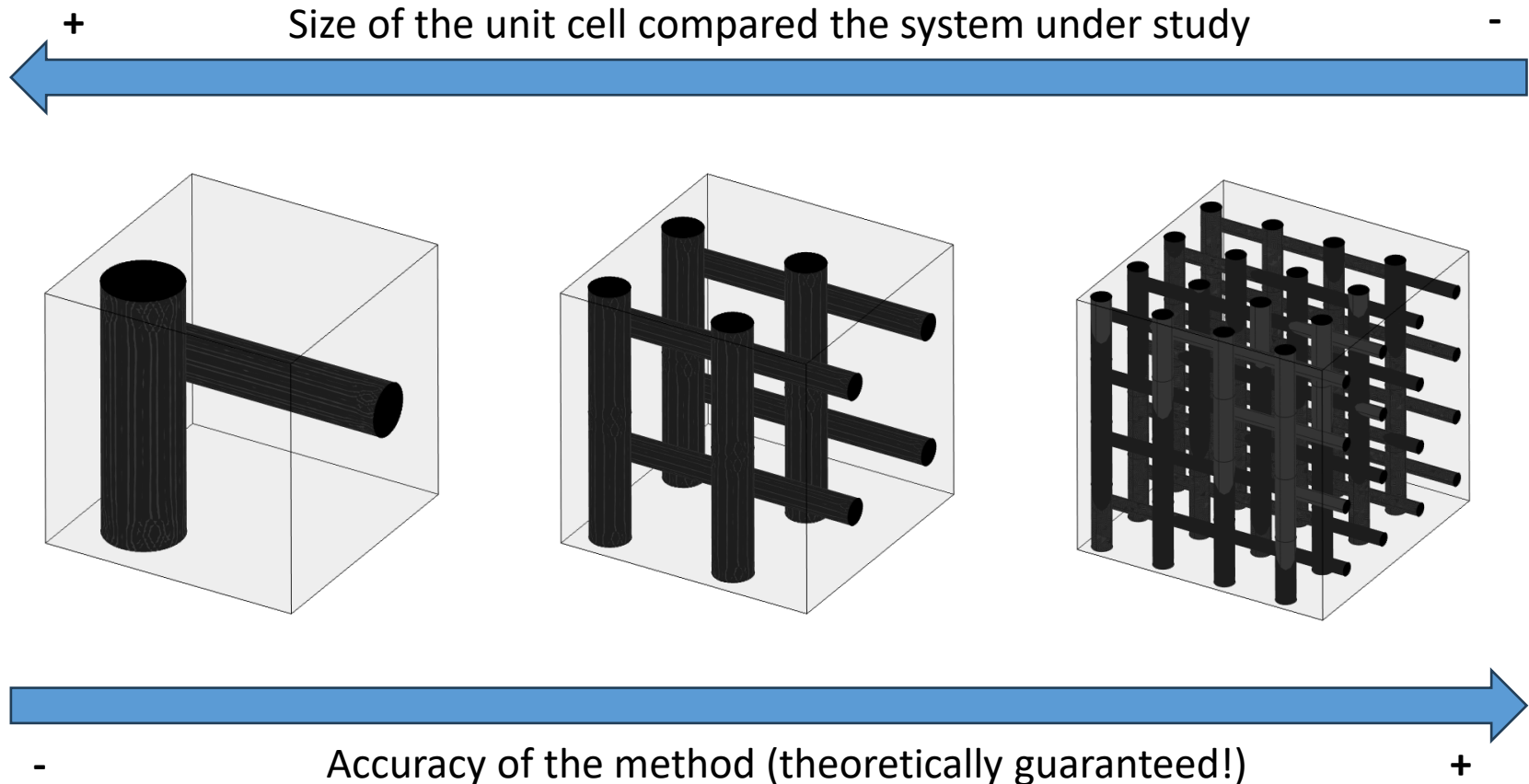


e.g. $\approx 300 \text{ k}$ DOF

Step 4: relocate → combine macroscopic and microscopic results to **get accurate results at microscale** (post-treatment)

Case study 2: Thermal and mechanical multiscale modelling

Modelling – Theoretical results of periodic homogenization

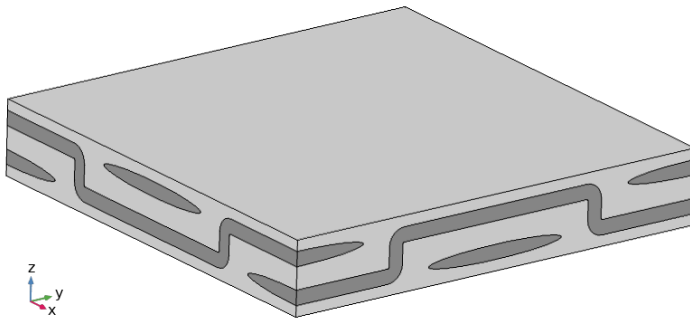


Identical computational cost !

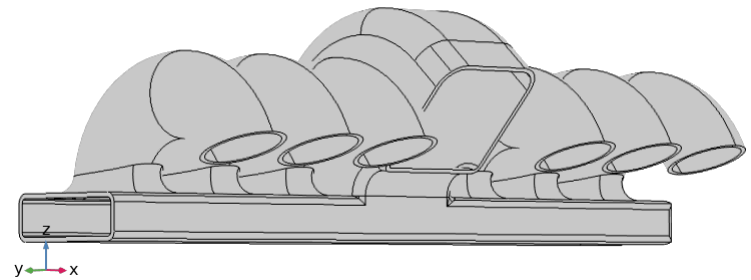
Case study 2: Thermal and mechanical multiscale modelling

Modelling – COMSOL implementation

Component 1: microstructure analysis



Component 2: macrostructure analysis



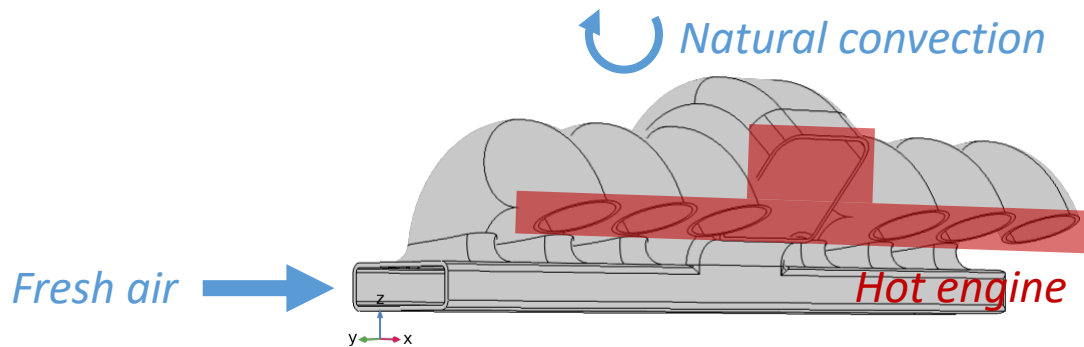
Non-exhaustive practical issues :

- ☐ Non-conventional system of PDEs
- ☐ Numerical care is needed: meshing, discretization orders...
- ☐ Automation required to implement *long* formulas

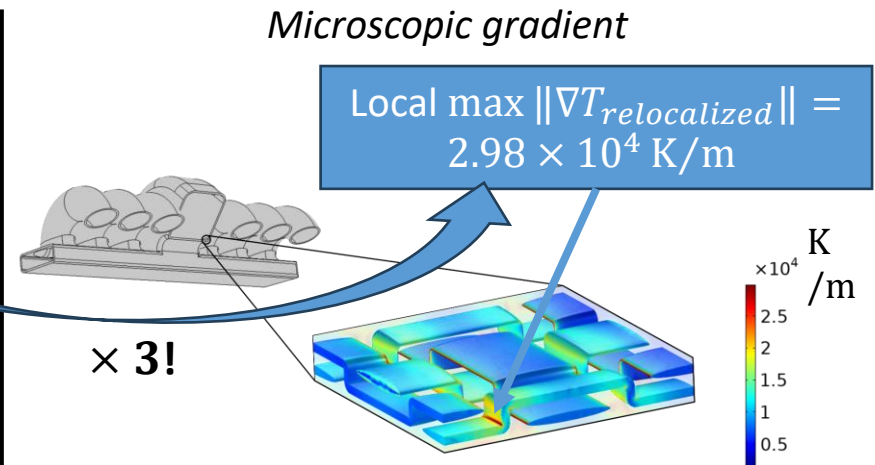
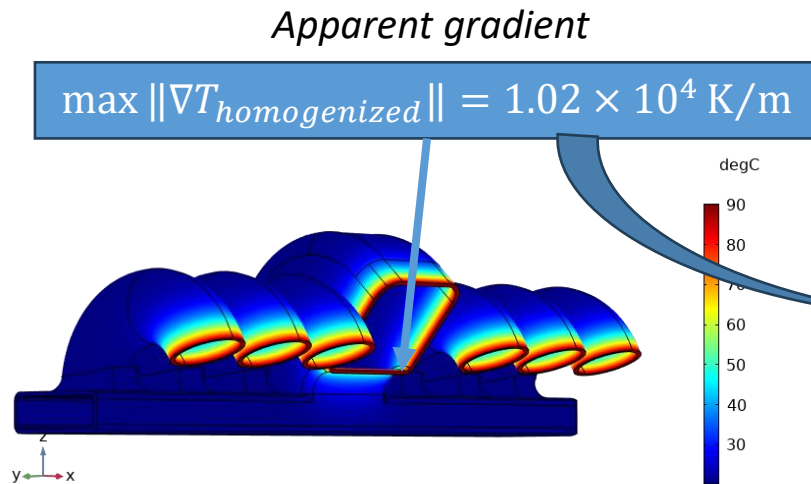
→ COMSOL Multiphysics® is flexible enough for that!

Case study 2: Thermal and mechanical multiscale modelling

Main Results – Heat transfer study case



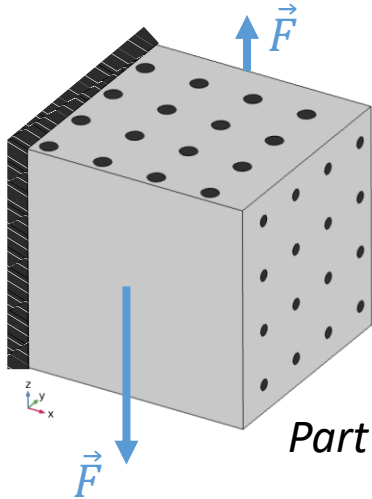
Goal: preventing delamination
→ maximal thermal gradient?



→ Only looking at homogenized variables may not be sufficient!

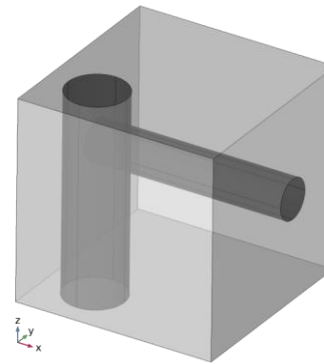
Case study 2: Thermal and mechanical multiscale modelling

Main Results – Solid mechanics study case



Part

= repetitions of



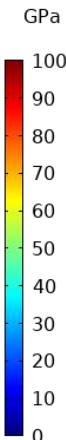
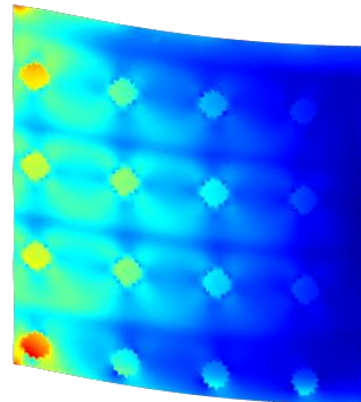
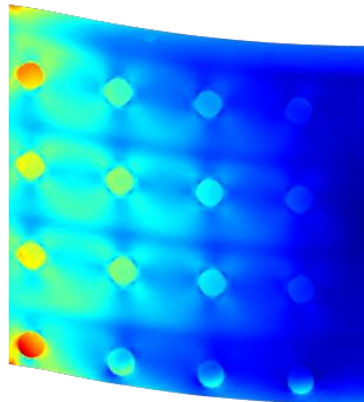
Unit cell

→ Mechanical stress within the part?

Direct FEA
1,8 M DOF/33 min

Periodic homogenization
0,3 M DOF/2.5 min

Von Mises
stress within a
cut plane



→ The method is very accurate!

→ The method is very efficient!

Case study 2: Thermal and mechanical multiscale modelling

Conclusions and Perspectives

- Understanding and predicting the microscopic behavior of parts made of microarchitected materials is important to design them
- Periodic homogenization is one of the techniques making the numerical analysis affordable and accurate
- **Major contribution:** generic implementation within COMSOL Multiphysics® for:
 - ☐ Heat transfers by conduction
 - ☐ Solid mechanics
- What about next steps?
 - ☐ Handling more physics
 - ☐ Dealing with nonlinearities
 - ☐ Applying the method to more industrial cases!

Q&A session

Thank you!

Q&A?

Our question: Who would like to try on our models? 😊



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